

SN74CBTLV16210 LOW-VOLTAGE 20-BIT FET BUS SWITCH

SCDS042F – DECEMBER 1997 – REVISED MAY 2000

- 5-Ω Switch Connection Between Two Ports
- Isolation Under Power-Off Conditions
- Package Options Include Plastic Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV), and Shrink Small-Outline (DL) Packages

NOTE: For tape and reel order entry:
The DGG package is abbreviated to GR, and
the DGV package is abbreviated to VR.

description

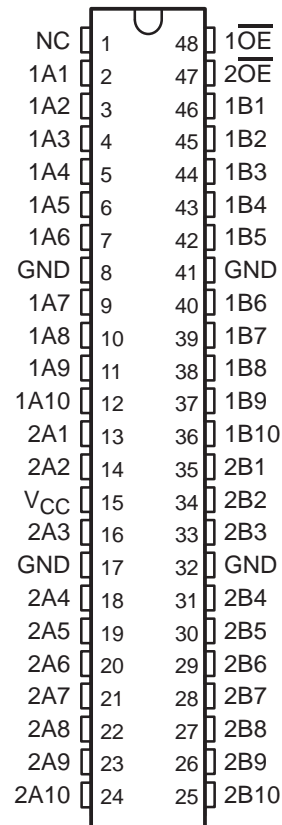
The SN74CBTLV16210 provides 20 bits of high-speed bus switching. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The device is organized as dual 10-bit bus switches with separate output-enable (\overline{OE}) inputs. It can be used as two 10-bit bus switches or as one 20-bit bus switch. When \overline{OE} is low, the associated 10-bit bus switch is on, and port A is connected to port B. When \overline{OE} is high, the switch is open, and the high-impedance state exists between the two ports.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74CBTLV16210 is characterized for operation from -40°C to 85°C .

DGG, DGV, OR DL PACKAGE (TOP VIEW)



NC – No internal connection

FUNCTION TABLE
(each 10-bit bus switch)

INPUT \overline{OE}	FUNCTION
L	A port = B port
H	Disconnect



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 **TEXAS
INSTRUMENTS**

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SN74CBTLV16210

LOW-VOLTAGE 20-BIT FET BUS SWITCH

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recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
V _{CC}	Supply voltage		2.3	3.6	V
V _{IH}	High-level control input voltage	V _{CC} = 2.3 V to 2.7 V	1.7		V
		V _{CC} = 2.7 V to 3.6 V	2		
V _{IL}	Low-level control input voltage	V _{CC} = 2.3 V to 2.7 V		0.7	V
		V _{CC} = 2.7 V to 3.6 V		0.8	
T _A	Operating free-air temperature		-40	85	°C

NOTE 3: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT
V _{IK}		V _{CC} = 3 V,	I _I = -18 mA			-1.2	V
I _I		V _{CC} = 3.6 V,	V _I = V _{CC} or GND			±1	μA
I _{off}		V _{CC} = 0,	V _I or V _O = 0 to 3.6 V			10	μA
I _{CC}		V _{CC} = 3.6 V,	I _O = 0, V _I = V _{CC} or GND			10	μA
ΔI _{CC} ‡	Control inputs	V _{CC} = 3.6 V,	One input at 3 V, Other inputs at V _{CC} or GND			300	μA
C _i	Control inputs	V _I = 3 V or 0				4.5	pF
C _{io(OFF)}		V _O = 3 V or 0, $\overline{OE} = V_{CC}$				6.5	pF
r _{on} §	V _{CC} = 2.3 V, TYP at V _{CC} = 2.5 V	V _I = 0	I _I = 64 mA	5	8	Ω	
			I _I = 24 mA	5	8		
		V _I = 1.7 V,	I _I = 15 mA	27	40		
	V _{CC} = 3 V	V _I = 0	I _I = 64 mA	5	7		
			I _I = 24 mA	5	7		
		V _I = 2.4 V,	I _I = 15 mA	10	15		

† All typical values are at V_{CC} = 3.3 V (unless otherwise noted), T_A = 25°C.

‡ This is the increase in supply current for each input that is at the specified voltage level rather than V_{CC} or GND.

§ Measured by the voltage drop between the A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1 and 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 3.3 V ± 0.3 V		UNIT
			MIN	MAX	MIN	MAX	
t _{pd} ¶	A or B	B or A	0.15		0.25		ns
t _{en}	\overline{OE}	A or B	1	6.8	1	6	ns
t _{dis}	\overline{OE}	A or B	1	7.3	1	7.4	ns

¶ The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

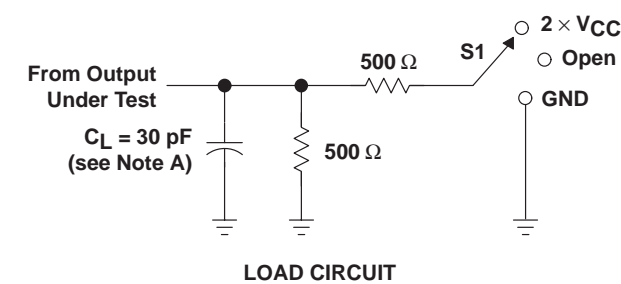


SN74CBTLV16210 LOW-VOLTAGE 20-BIT FET BUS SWITCH

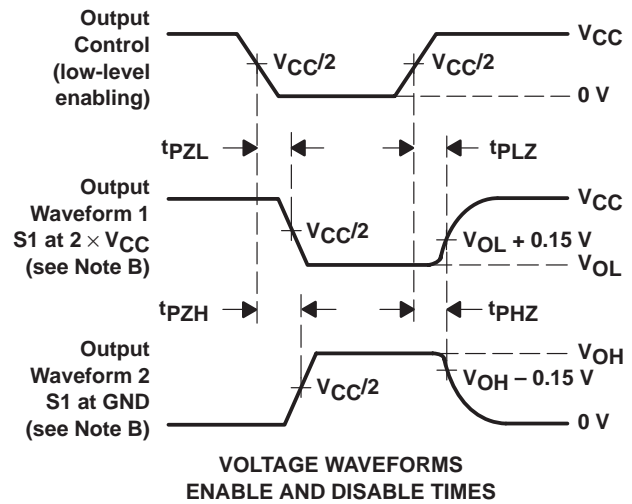
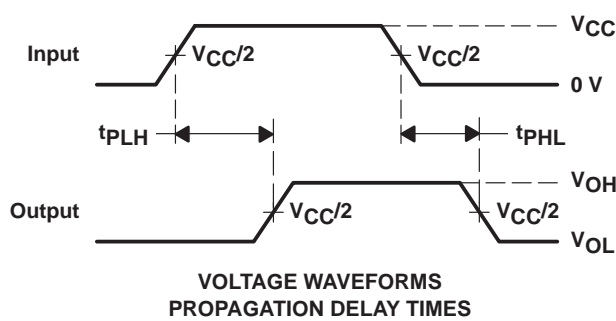
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PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$$



TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	2 \times V_{CC}
t_{PHZ}/t_{PZH}	GND

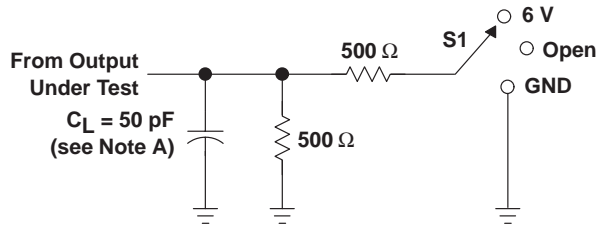


- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2 \text{ ns}$, $t_f \leq 2 \text{ ns}$.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .

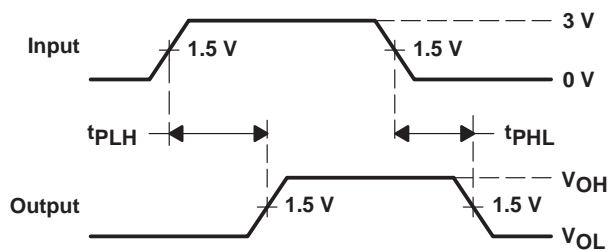
Figure 1. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$

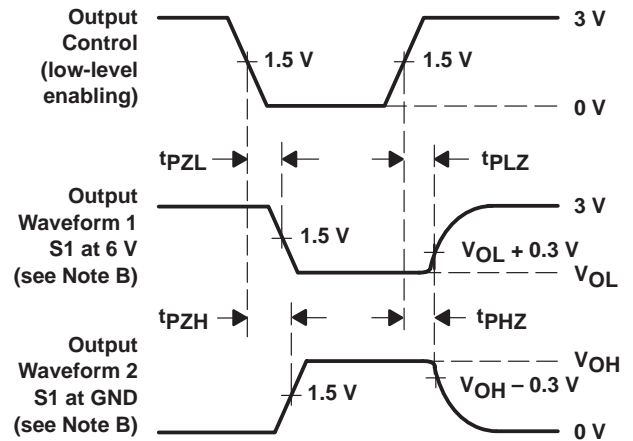


LOAD CIRCUIT



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES

TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	6 V
t_{PHZ}/t_{PZH}	GND



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
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 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 2. Load Circuit and Voltage Waveforms

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SN74CBTLV16210, Low-Voltage 20-Bit FET Bus Switch

Device Status: Active

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- > [Pricing/Samples/Availability](#)
- > [Application Notes](#)
- > [Related Documents](#)
- > [Training](#)

Parameter Name	SN74CBTLV16210
Voltage Nodes (V)	3.3, 2.5
Vcc range (V)	2.3 to 3.6
No. of Bits	20
ron(max) (ohms)	7
tpd(max) (ns)	0.25

Description

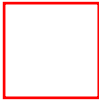
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Features

- 5-  Switch Connection Between Two Ports
- Isolation Under Power-Off Conditions
- Package Options Include Plastic Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV), and Shrink Small-Outline (DL) Packages

NOTE: For tape and reel order entry:

The DGGR package is abbreviated to GR, and

the DGVR package is abbreviated to VR.

To view the following documents, [Acrobat Reader 3.x](#) is required.

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Datasheets

Full datasheet in Acrobat PDF: [scds042f.pdf](#) (86 KB)

Full datasheet in Zipped PostScript: [scds042f.psz](#) (83 KB)

Pricing/Samples/Availability

<u>Orderable Device</u>	<u>Package</u>	<u>Pins</u>	<u>Temp (°C)</u>	<u>Status</u>	<u>Price/unit USD (100-999)</u>	<u>Pack Qty</u>	<u>Availability / Samples</u>
SN74CBTLV16210DL	DL	48	-40 TO 85	ACTIVE	3.00	25	Check stock or order
SN74CBTLV16210DLR	DL	48	-40 TO 85	ACTIVE	2.51	1000	Check stock or order
SN74CBTLV16210G	DGG	48		PREVIEW			Check stock or order
SN74CBTLV16210GR	DGG	48	-40 TO 85	ACTIVE	2.51	2000	Check stock or order
SN74CBTLV16210VR	DGV	48	-40 TO 85	ACTIVE	2.84	2000	Check stock or order

Application Reports

View Application Reports for [Digital Logic](#)

- [5-V To 3.3-V Translation With The SN74CBTD3384](#) (SCDA003B - Updated: 03/01/1997)
- [Low-Voltage Bus-Switch Technology And Applications](#) (SCDA005 - Updated: 12/01/1997)
- [SN74CBTS3384 Bus Switches Provide Fast Connection And Ensure Isolation](#) (SCDA002A - Updated: 08/01/1996)
- [TI Logic Solutions for Memory Interleaving With the Intel440BX Chipset](#) (SCCA001 - Updated: 04/08/1999)
- [Texas Instruments Crossbar Switches](#) (SCDA001A - Updated: 06/01/1995)
- [Texas Instruments Solution for Undershoot Protection for Bus Switches](#) (SCDA007 - Updated: 04/13/2000)

Related Documents

- [Documentation Rules \(SAP\) And Ordering Information](#) (SZZU001B, 4 KB - Updated: 05/06/1999)
- [Logic Selection Guide Second Half 2000](#) (SDYU001N, 5035 KB - Updated: 04/17/2000)
- [MicroStar Junior BGA Design Summary](#) (SCET004, 284 KB - Updated: 07/28/2000)
- [More Power In Less Space - Technical Article](#) (SCAU001A, 850 KB - Updated: 03/01/1996)

Table Data Updated on: 8/31/2000

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